

3.0x1.5 mm SMD CHIP LED LAMP

APL3015MGC

MEGA GREEN

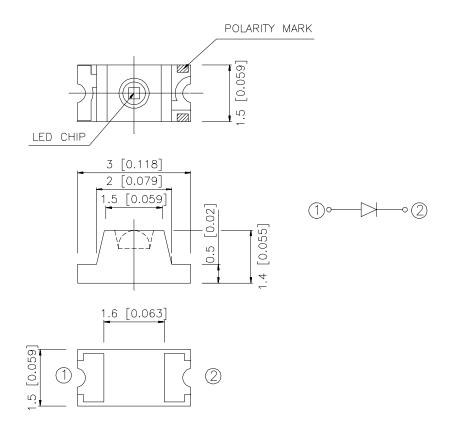
Features

- •3.0mmx1.5mm SMT LED, 1.4mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •INNER LENSTYPE
- •PACKAGE: 2000PCS/REEL.

Description

The Mega Green source color devices are made with DH InGaAIP on GaAs substrate Light Emitting Diode.

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.0079")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) @ 20 mA		Viewing Angle
			Min.	Тур.	201/2
APL3015MGC	MEGA GREEN (InGaAIP)	WATER CLEAR	70	140	70°

Note:

Electrical / Optical Characteristics at T_A=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Mega Green	574		nm	IF=20mA
λD	Dominate Wavelength	Mega Green	568		nm	IF=20mA
Δλ 1/2	Spectral Line Half-width	Mega Green	26		nm	IF=20mA
С	Capacitance	Mega Green	20		pF	V F=0V;f=1MHz
VF	Forward Voltage	Mega Green	2.1	2.5	V	IF=20mA
IR	Reverse Current	Mega Green		10	uA	V R = 5V

Absolute Maximum Ratings at T_A=25°C

Parameter	Mega Green	Units
Power dissipation	105	mW
DC Forward Current	30	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

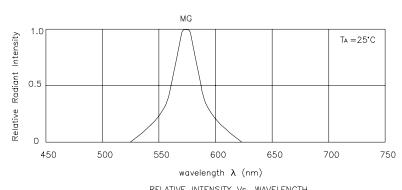
Note:

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^{1.} θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

^{1. 1/10} Duty Cycle, 0.1ms Pulse Width.

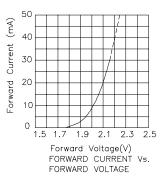
Kingbright

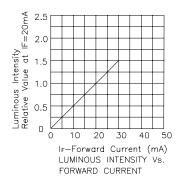


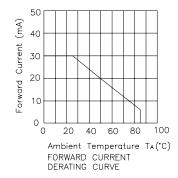
RELATIVE INTENSITY Vs. WAVELENGTH

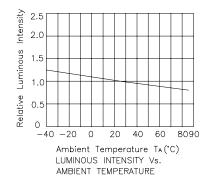
Mega Green

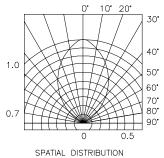
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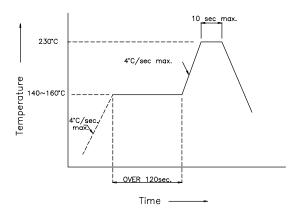
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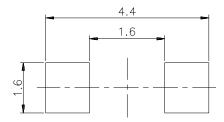
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SMT Reflow Soldering Instructions

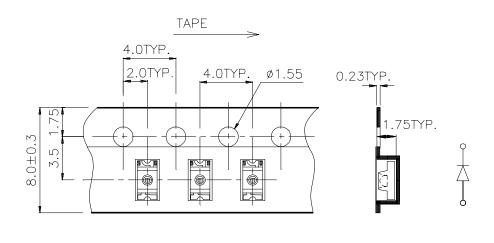
Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and second soldering process.



Recommended Soldering Pattern (Units:mm)



Tape Specifications (Units:mm)



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